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By: 10-21-03
Aileen C. Franklin

PATENT
Attorney Docket No. 20843-000110

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

JESUS AL ORTIZ et al.

Application No.: Unassigned
Parent Appln. No.: 09/785,973

Filed: Herewith
Parent Filed: February 16, 2001

For: ELECTROMAGNETIC
INTERFERENCE SHIELD OF
ELECTRICAL CABLES AND
CONNECTORS

Examiner: Unassigned
Parent Exr. M. Trinh

Art Unit: Unassigned
Parent Art: 3729

**INFORMATION DISCLOSURE
STATEMENT**

Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

The references cited on attached form PTO-1449 are being called to the attention of the Examiner. Copies were provided in the parent application (USSN 09/785,973) and therefore are not enclosed herewith pursuant to 37 CFR 1.98(d), unless otherwise indicated. It is respectfully requested that the cited references be expressly considered during the prosecution of this application, and the references be made of record therein and appear among the "references cited" on any patent to issue therefrom.

As provided for by 37 CFR 1.97(g) and (h), no inference should be made that the information and references cited are prior art merely because they are in this statement and no representation is being made that a search has been conducted or that this statement encompasses all the possible relevant information.

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PATENT

Applicant believes that no fee is required for submission of this statement, since it is being submitted prior to the first Office Action. However, if a fee is required, the Commissioner is authorized to deduct such fee from the undersigned's Deposit Account No. 20-1430. Please deduct any additional fees from, or credit any overpayment to, the above-noted Deposit Account.

Respectfully submitted,

Dated: 10/21/03

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FORM PTO-1449 (Modified)			Attorney Docket No.: 20843-00010US		Application No. Unassigned	
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)			Applicant: JESUS AL ORTIZ et al.			
			Filing Date: Herewith		Group: Unassigned	
Reference Designation			U.S. PATENT DOCUMENTS			Page 1
Examiner Initial	Document No.	Date	Name	Class	Sub-class	Filing Date (If Appropriate)
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___ AB	3,639,674	02/1972	Stier			
___ AC	3,744,128	07/1973	Fisher et al.			
___ AD	4,106,839	08/1978	Cooper			
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FOREIGN PATENT DOCUMENTS						
	Document No.	Date	Country	Class	Sub-class	Translation (Yes/No)
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)						
___ CL	Adams; <i>Taking the Mystery Out of Metallizing</i> , Vacuum Technology (November 1975) Technical Publishing Company, 4 pages total.					
___ CM	Adams; <i>Taking the Mystery Out of Metallizing-II</i> , Vacuum Technology (December 1975) Technical Publishing Company, 3 pages total.					
___ CN	Adams; <i>Taking the Mystery Out of Metallizing-III</i> , Vacuum Technology (February 1976) Technical Publishing Company, 4 pages total.					
___ CO	Gabower, <i>Thermoformed Vacuum-Metallized Inserts For EMI Shielding</i> , ITEM (1995) The International Journal of EMC, Robar Industries, Inc., pp. 120, 122, 123, and 127.					

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		Filing Date: Herewith	Group: Unassigned
_____ CP	Gabower, <i>Thermoformed Vacuum Metallized Inserts For EMI Shielding of Electronic Devices</i> , Consumer Electronics Show, Flamingo Hilton and Tower, Las Vegas, Nevada, pp. 151-158.		
_____ CQ	Gwinner, <i>Vacuum Evaporated Aluminum for Selective Shielding of Plastic Housings</i> , ITEM (1993) The International Journal of EMC, Robar Industries, Inc., pp. 138, 140, 290, 292, 294, and 296.		
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_____ CU	Smock, <i>Trend to Lower Cost Resins Will Accelerate</i> , Plastics World (April 1995) 1 page total.		
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_____ DB	<i>EMI/REI Shielding Guide</i> , General Electric Plastics Co. pp. 1-50.		
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_____ DD	<i>6100 Thermoformable EMI-Shielding Material</i> , Minnesota Mining & Mfg. Co. (1994) 2 pages total.		
_____ DE	<i>Orion® Designs Economical EMI Shielding Box Without Cutting Corners</i> , Product Brochure, Orion® Industries Incorporated, 1 page total.		
_____ DF	<i>New Solutions for the Electronic Age</i> , Placon Corp., Madison, Wisconsin, Sales Brochure, 1 page total.		
_____ DG	<i>Silver-Coated VALOX FR-1 Film Provides Shielding For Circuit Breakers</i> , GE Films in Action (June 1994) General Electric Co., 1 page total.		
_____ DH	<i>Style CBS Circuit Board Component Shielding - Design Guide 4</i> , Product Brochure, Leader Tech., Tampa, Florida, 2 pages total.		
_____ DI	<i>Ultrasonic Welders Advance Clamshell-Sealing Process</i> , Packaging (October 1994) pp. 78-21.		
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_____ DL	<i>Silver Shielding for the Highest Performance</i> , Swift Textile Metalizing Corporation, ITEM (1995) pp. 11, 15, 109, 112, 113, 115, 116, 212, 213, 267, 269.		
EXAMINER		DATE CONSIDERED	

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.